



ZHCS500

#### SURFACE MOUNT SCHOTTKY BARRIER DIODE

### **Product Summary**

- V<sub>R</sub> = 40V
- I<sub>F</sub> = 500mA
- $I_R = 40 \mu A$

## **Applications**

- DC DC Converters
- Mobile Telecomms
- PCMIA

### **Features**

- High Current Capability (I<sub>F</sub> = 500mA)
- Low V<sub>F</sub>
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.0089 grams (approximate)





Top View



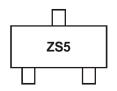
### **Ordering Information** (Note 4)

Part Number	Case	Packaging
ZHCS500TA	SOT23	3000/Tape & Reel
ZHCS500QTA	SOT23	3000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For Packaging Details, go to our website at http://www.diodes.com.

## **Marking Information**



ZS5 = Product Type Marking Code



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Continuous Reverse Voltage		V <sub>R</sub>	40	V
Continuous Forward Current		l <sub>F</sub>	500	mA
Forward Voltage @ I <sub>F</sub> = 500mA		V <sub>F</sub>	550	mV
Average Peak Forward Current; D.C. = 50%		I <sub>FAV</sub>	1000	mA
Non Repetitive Forward Current	t ≤ 100µs	1	6.75	Α
	t ≤ 10ms	IFSM	3	Α

## **Thermal Characteristics**

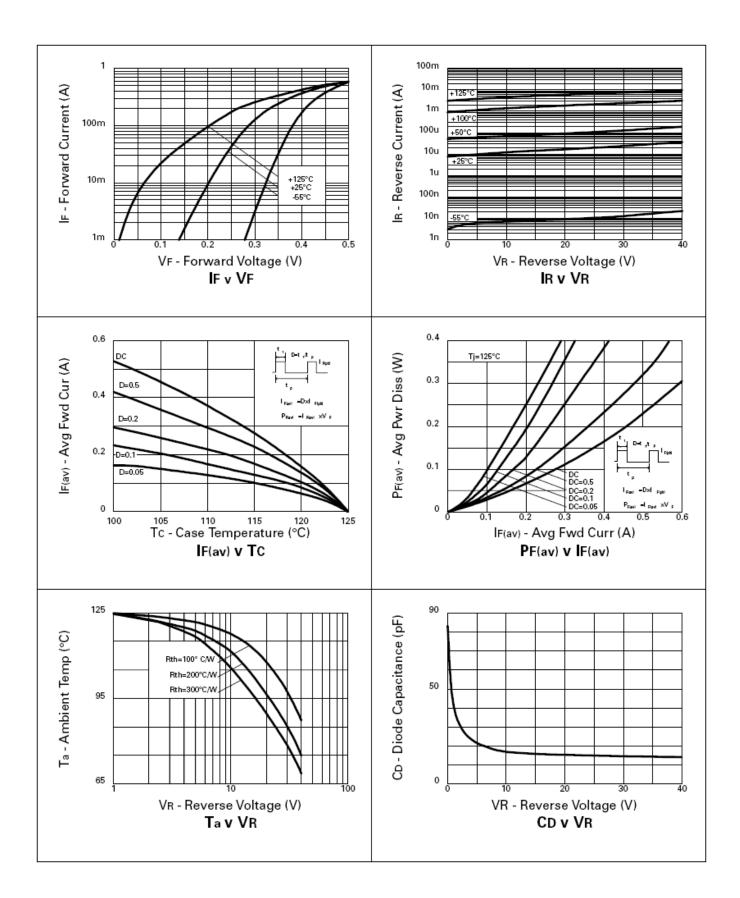
Characteristic	Symbol	Value	Unit
Power Dissipation, T <sub>A</sub> = +25°C	P <sub>D</sub>	330	mW
Junction Temperature	$T_J$	125	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

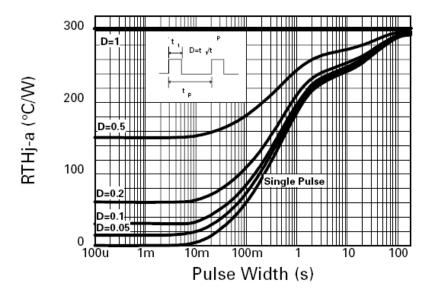
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	V <sub>(BR)R</sub>	40	60	_	V	I <sub>R</sub> = 200μA
	, ,	_	270	300	mV	$I_F = 50 \text{mA}$
		_	300	350		$I_F = 100 \text{mA}$
		_	370	460		I <sub>F</sub> = 250mA
Forward Valtage (Note 5)	\/_	_	465	550		$I_F = 500 \text{mA}$
Forward Voltage (Note 5)	VF	_	550	670		I <sub>F</sub> = 750mA
		_	640	780		I <sub>F</sub> = 1A
		_	810	1050		I <sub>F</sub> = 1.5A
		_	440	_		$I_F = 500 \text{mA}, T_A = +100 ^{\circ}\text{C}$
Reverse Current	I <sub>R</sub>	_	15	40	μA	$V_R = 30V$
Diode Capacitance	$C_D$	_	20	_	pF	$f = 1MHz, V_R = 25V$
		_	10	_	ns	Switched from I <sub>F</sub> = 500mA to
Reverse Recovery Time	trr					$I_R = 500 \text{mA}$
						Measured @ I <sub>R</sub> = 50mA

Notes: 5. Measured under pulsed conditions. Pulse width =  $300\mu$ S. Duty cycle – 2%.



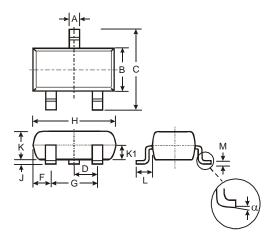






## **Package Outline Dimensions**

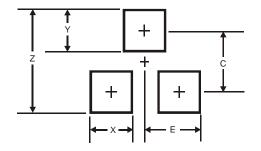
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
C	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
7	0.013	0.10	0.05		
K	0.903	1.10	1.00		
K1	-	-	0.400		
L	0.45	0.61	0.55		
М	0.085	0.18	0.11		
α	0°	8°	-		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
Z	2.9		
Х	0.8		
Y	0.9		
С	2.0		
E	1.35		



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